

# Toshiba starts sample shipment of industry's first embedded NAND flash memory modules

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Toshiba Corporation today announced that it has started sample shipments of a 64-gigabyte (GB) embedded NAND flash memory module, the first in the industry equipped with a UFS I/F. The module is fully compliant with the JEDEC UFS Ver.1.1 standard and is designed for application in a wide range of digital consumer products, including smartphones, tablet PCs.

Samples are mainly intended for evaluation of UFS I/F and its protocol in host chipsets and by OS vendors.

Demand continues to grow for large density, high-performance chips that support high resolution video, driven by improved data-processing speeds in host chipsets and wider bandwidths for [wireless connectivity](#).

Toshiba has proved itself an innovator in this key area, and is now reinforcing its leadership by being first in the industry to support samples with a 64GB UFS module.

Toshiba will schedule mass-production and other densities in its line-up according to market demand.

**More information:** Part Number: THGLF0G9B8JBAIE

Provided by Toshiba Corporation

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